



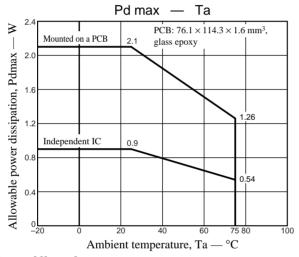
Four-Channel Bridge (BTL) Driver for CD-ROM

Overview

The LA6545M is a 4-channel bridge (BTL) driver developed for use in CD-ROM systems.

Functions

- Bridge connected (BTL) four-channel power amplifier
- V_{CE} (residual voltage) minimized (channels 1 and 2) by using two power supplies.
- Iomax: 1.0 A
- Muting circuit provided (output on/off control)



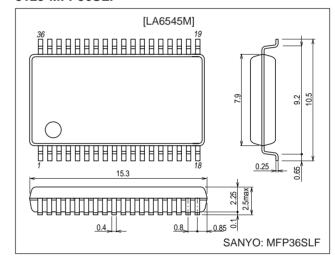
(MUTE pin: low for output off, high for output on. MUTE1: controls channels 1, 2, and 3, MUTE2: controls channel 4.)

- Thermal protection (shutdown) circuit
- Separated output stage power supply (VS1: channels 1 and 2, VS2: channels 3 and 4)

Package Dimensions

unit: mm

3129-MFP36SLF



Specifications

Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage 1	V _{CC} max	V _{CC} ≥ V _S 1, 2	14	V
Maximum supply voltage 2	V _S max	V _S 1, 2, V _{CC} ≥ V _S 1, 2	14	V
Input voltage	V _{IN} max	Each of the input pins V _{IN} 1 to V _{IN} 4	13	V
MUTE pin voltage	V _{MUTE} max		13	V
Allowable news dissination	Pd max	Independent IC	0.9	W
Allowable power dissipation		Mounted on the specified PCB (76.1 × 114.3 × 1.6 mm³, glass epoxy)	2.1	W
Operating temperature	Topr		-20 to +75	°C
Storage temperature	Tstg		-55 to +150	°C

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Recommended Operating Conditions at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
	$V_{CC} \qquad V_{CC} \ge V_S 1, 2$		4 to 13	V
Operating supply voltage	V _S 1, 2	V_S1 and V_S2 are the output stage power supply. $V_{CC} \ge V_S1$ and V_S2	4 to 13	V

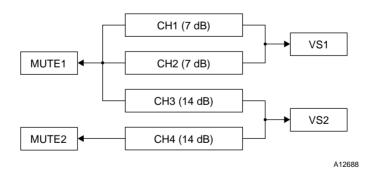
Electrical Characteristics at $Ta=25^{\circ}C$, $V_{CC}=V_{S}2=12~V$, $V_{S}1=5~V$, $V_{REF}=1.65~V$

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Parameter	Symbol	Conditions	min	typ	max	Unit
V _{CC} no load current drain 1	I _{CC} -ON	Output on (MUTE1 and MUTE2: high), V _{CC}		10	25	mA
V _{CC} no load current drain 2	I _{CC} -OFF	Output off (MUTE1 and MUTE2: low), V _{CC}			4	mA
VS1 no load current drain 1	I _S 1-ON	Output on (MUTE1 and MUTE2: high), V _S 1		20	30	mA
VS1 no load current drain 2	I _S 2-OFF	Output off (MUTE1 and MUTE2: low), V _S 1			4	mA
VS2 no load current drain 1	I _S 2-ON	Output on (MUTE1 and MUTE2: high), V _S 2		20	30	mA
VS2 no load current drain 2	I _S 2-OFF	Output off (MUTE1 and MUTE2: low), V _S 2			4	mA
Output offset voltage	V _{OF} 1 to 4	Potential difference between the + and – outputs for each channel	-50		+50	mV
Input voltage range 1	V _{IN} 1	Input voltage range for each channel	0		V _S 1	V
Output voltage 1	VO1	I_{O} = 700 mA, the difference between the outputs for channels 1 and 2	4	4.5		٧
Output voltage 2	VO2	I_{O} = 700 mA, the difference between the outputs for channels 3 and 4	10.5	11		V
Closed circuit valtage gain	VG1	The BTL amplifier voltage gain for channels 1 and 2	5	7	9	dB
Closed circuit voltage gain	VG2	The BTL amplifier voltage gain for channels 3 and 4	12	14	16	dB
Slew rate	SR	This value is doubled when measured across the outputs. *1		0.5		V/µs
Muting on voltage	V _{MUTE}	MUTE1 and MUTE2. The voltage at which the output turns on. *2		1.5	2	V

Notes 1. Design guarantee value.

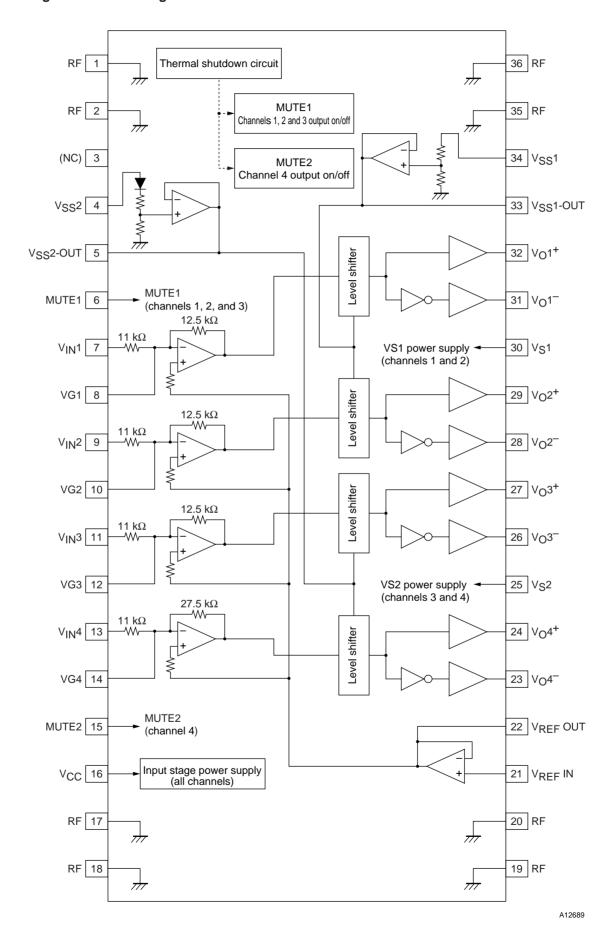
The figure below shows the relationship between the channels and the MUTE pins and between the channels and the power supplies.

System Figure



^{2.} The MUTE1, and MUTE2 pins turn the output on when high and off when low. When the output is off, the outputs will be in the high-impedance state.

Block Diagram and Pin Assignment

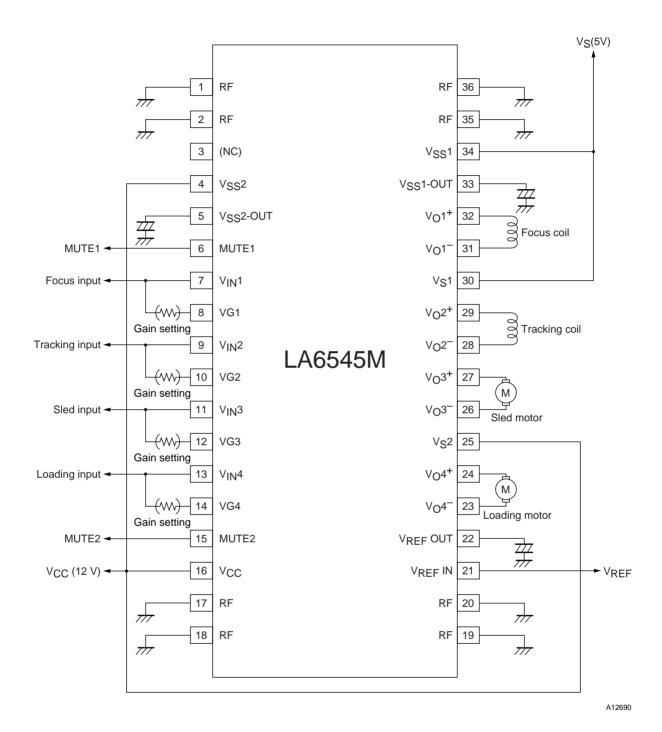


LA6545M

Pin Functions

Pin No.	Pin	Function
1	RF	Substrate (lowest potential)
2	RF	Substrate (lowest potential)
3	(NC)	Unused.
4	V _{SS} 2	Connect to V _S 2.
5	V _{SS} 2-OUT	Output stage reference voltage output ((V _S 2-VBE)/2, typical)
6	MUTE1	Channels 1, 2, and 3 output on/off control
7	V _{IN} 1	Channel 1 input
8	VG1	Channel 1 input (gain adjustment)
9	V _{IN} 2	Channel 2 input
10	VG2	Channel 2 input (gain adjustment)
11	V _{IN} 3	Channel 3 input
12	VG3	Channel 3 input (gain adjustment)
13	V _{IN} 4	Channel 4 input
14	VG4	Channel 4 input (adjustment)
15	MUTE2	Channel 4 on/off control
16	V _{CC}	Power supply
17	RF	Substrate (lowest potential)
18	RF	Substrate (lowest potential)
19	RF	Substrate (lowest potential)
20	RF	Substrate (lowest potential)
21	V _{REF} IN	Reference voltage input (V _{REF} 1 buffer amplifier input)
22	V _{REF} OUT	Reference voltage output (V _{REF} 1 buffer amplifier output)
23	V _O 4-	Channel 4 inverted output
24	V _O 4+	Channel 4 noninverted output
25	V _S 2	Channes 3 and 4 output stage power supply
26	V _O 3-	Channel 3 inverted output
27	V _O 3+	Channel 3 noninverted output
28	V _O 2-	Channel 2 inverted output
29	V _O 2+	Channel 2 noninverted output
30	V _S 1	Channels 1 and 2 output stage power supply
31	V _O 1-	Channel 1 inverted output
32	V _O 1+	Channel 1 noninverted output
33	V _{SS} 1-OUT	Output stage reference voltage (Outputs V _{SS} /2: typical) (V _{REF} 2 buffer amplifier output)
34	V _{SS} 1	Connect to V _S 1. (V _{SS} 1 - OUT is generated by a resistor divider.)
35	RF	Substrate (lowest potential)
36	RF	Substrate (lowest potential)

Sample Application Circuit



LA6545M

Pin Description

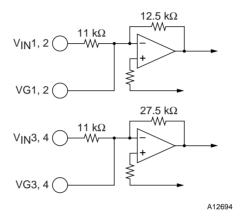
Pin No.	Pin	Symbol	Function	Equivalent circuit
7 8 9 10 11 12 13 14	V _{IN} * VG* (Input)	V _{IN} 1 VG1 V _{IN} 2 VG2 V _{IN} 3 VG3 V _{IN} 4 VG4	Inputs for each channel	VCC (1) (9) (13) (7) (11) (14) (19) (19) (19) (19) (19) (19) (19) (19
32 31 29 28 27 26 24 23	V _O * (Output)	V ₀ 1+ V ₀ 1- V ₀ 2+ V ₀ 2- V ₀ 3+ V ₀ 3- V ₀ 4+ V ₀ 4-	Outputs for each channel	VS VCC VCC VCC VCC VCC (3) (4) (8) (2) (3) (3) (3) (3) (3) (3) (3) (3) (3) (3
6 15	MUTE	MUTE1 MUTE2	Output on/off control	VCC 6 MUTE1, 2 15 RF A12693

Gain Setting (Functions of the Input and Gain Adjustment Pins)

The figures present overviews of the V_{IN} and VG pin circuits. (These are the same as the block diagrams.)

- 1. Consider resistors (11 k Ω , typical) to be inserted between the V_{IN} and VG pins. This should be seen as being the same as the operational amplifier noninverting input (V_{IN}^+).
- 2. If the VG pins are not used, and only the V_{IN} pins are used, the BTL gain (across the V_{O^+} and V_{O^-} outputs) will be 7 dB for channels 1 and 2 (amplifier units: 1 dB + BTL: 6 dB) and 14 dB for channels 3 and 4 (amplifier units: 8 dB + BTL: 6 dB).

If the V_{IN} pins are not used and 11 k Ω external resistors are attached to the VG pins, input to the opposite ends of those resistors will result in equivalent circuit operation. However, the V_{IN} pins should be used and the gain set to minimize the I/O gain temperature characteristics.



Offset Voltage

This IC includes built-in level shifting circuits. For input to which V_{REF} is applied as a reference, the output is referenced to the voltage $V_{SS}1/2$ (V) for channels 1 and 2, and the output is referenced to the voltage $(V_{SS}2 - V_{BE}(0.7))/2$ (V) for channels 3 and 4.

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